



LOW CAPACITANCE BIDIRECTIONAL TVS DIODES

Features

- Low Profile Package (0.53mm max) and Ultra-Small PCB Footprint Area (1.08 * 0.68mm max) Suitable for Compact Portable Electronics
- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±30kV, Contact ±25kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Typically Used in Cellular Handsets, Portable Electronics, Communication Systems, Computers and Peripherals
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- · Polarity: Cathode Band
- Weight: 0.001 grams (Approximate)

X1-DFN1006-2



Bottom View



Device Schematic

Ordering Information (Note 4)

Ī	Product	Compliance	Marking	Reel Size(inches)	Tape Width(mm)	Quantity per Reel
	DESD3V3S1BL-7B	Standard	RH	7	8	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

X1-DFN1006-2



RH = Product Type Marking Code Line Denotes Pin#1



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P_PP	35	W	8/20µs, Per Figure 3
Peak Pulse Current	Ipp	5	Α	8/20µs, Per Figure 3
ESD Protection – Contact Discharge	V _{ESD_CONTACT}	±25	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V _{ESD_AIR}	±30	kV	IEC 61000-4-2 Standard

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P _D	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V_{RWM}	_	_	3.3	V	_
Channel Leakage Current (Note 6)	I _{RM}	_	10	100	nA	$V_{RWM} = 3.3V$
Clamping Voltage, Positive Transients	V _{CL}	_	4.5	5.4	V	$I_{PP} = 1A$, $t_P = 8/20 \mu s$
Clamping voltage, Fositive Transients	V CL	_	5.8	7.0		$I_{PP} = 5A$, $t_P = 8/20 \mu s$
Breakdown Voltage	V_{BR}	3.8	_	6.5	V	$I_R = 1mA$
Differential Resistance	R _{DIF}	_	0.3	_	Ω	I _R = 1A
Channel Input Capacitance	Ст	_	10	13	pF	$V_R = 0V$, $f = 1MHz$

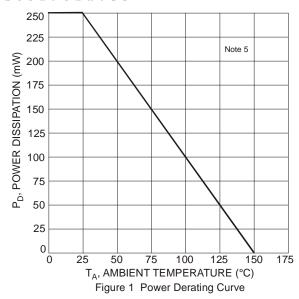
Notes:

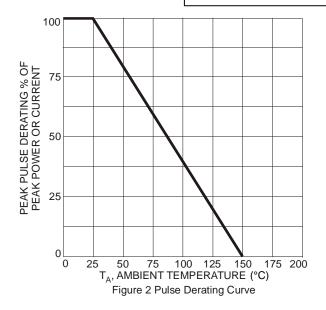
^{5.} Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

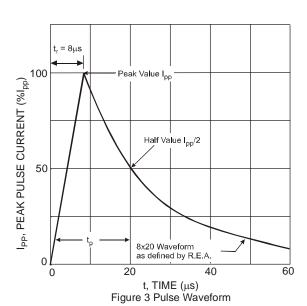
^{6.} Short duration pulse test used to minimize self-heating effect.

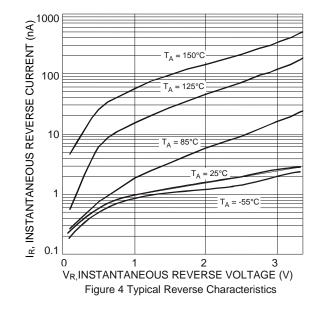


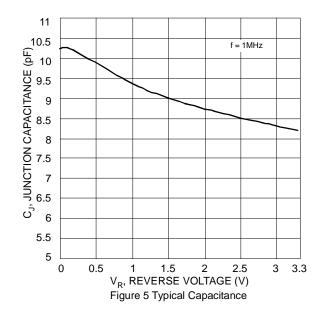
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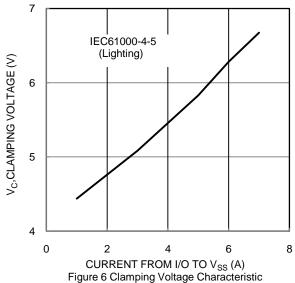




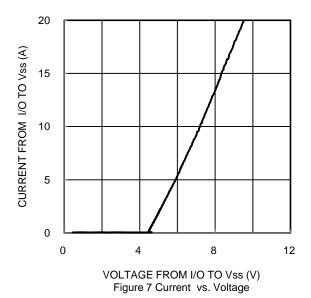










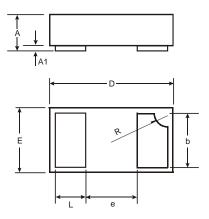




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

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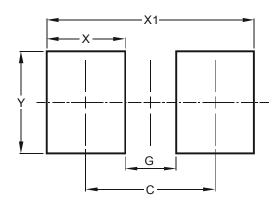


X1-DFN1006-2					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A1	0	0.05	0.03		
b	0.45	0.55	0.50		
D	0.95	1.075	1.00		
Е	0.55	0.675	0.60		
е	-	-	0.40		
L	0.20	0.30	0.25		
R	0.05	0.15	0.10		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-2



Dimensions	Value (in mm)		
С	0.70		
G	0.30		
Х	0.40		
X1	1.10		
Y	0.70		



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